DISCRETE SEMICONDUCTORS



Product specification Supersedes data of April 1995 File under Discrete Semiconductors, SC07 1996 Jul 30



J108; J109; J110

FEATURES

- High speed switching
- Interchangeability of drain and source connections
- Low R_{DSon} at zero gate voltage (<8 Ω for J108).

APPLICATIONS

- Analog switches
- Choppers and commutators.

DESCRIPTION

N-channel symmetrical silicon junction field-effect transistors in a TO-92 package.

CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static discharge during transport or handling.

QUICK REFERENCE DATA

PINNING - TO-92

PIN	SYMBOL	DESCRIPTION
1	g	gate
2	s	source
3	d	drain



SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage		-	±25	V
V _{GSoff}	gate-source cut-off voltage	$I_{D} = 1 \ \mu A; V_{DS} = 5 \ V$			
	J108		-3	–10	V
	J109		-2	-6	V
	J110		-0.5	-4	V
I _{DSS}	drain current	$V_{GS} = 0; V_{DS} = 5 V$			
	J108		80	-	mA
	J109		40	_	mA
	J110		10	-	mA
P _{tot}	total power dissipation	up to T _{amb} = 50 °C	-	400	mW

J108; J109; J110

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage		-	±25	V
V _{GSO}	gate-source voltage	open drain	-	-25	V
V _{GDO}	gate-drain voltage	open source	_	-25	V
l _G	forward gate current (DC)		-	50	mA
P _{tot}	total power dissipation	up to $T_{amb} = 50 \ ^{\circ}C$	-	400	mW
T _{stg}	storage temperature		-65	150	°C
Tj	operating junction temperature		_	150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	250	K/W

STATIC CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)GSS}	gate-source breakdown voltage	$I_{G} = -1 \ \mu A; V_{DS} = 0$	-	-	-25	V
V _{GSoff}	gate-source cut-off voltage	$I_D = 1 \ \mu A; \ V_{DS} = 5 \ V$				V
	J108		-3	-	-10	V
	J109		-2	-	-6	V
	J110		-0.5	-	-4	V
I _{DSS}	drain current	V _{GS} = 0; V _{DS} = 15 V				
	J108		80	-	-	mA
	J109		40	_	_	mA
	J110		10	_	_	mA
I _{GSS}	gate leakage current	$V_{GS} = -15 \text{ V}; V_{DS} = 0$	-	-	-3	nA
I _{DSX}	drain-source cut-off current	$V_{GS} = -10 \text{ V}; \text{ V}_{DS} = 5 \text{ V}$	-	-	3	nA
R _{DSon}	drain-source on-state resistance	$V_{GS} = 0; V_{DS} = 100 \text{ mV}$				
	J108		-	_	8	Ω
	J109		-	-	12	Ω
	J110		-	-	18	Ω

J108; J109; J110

DYNAMIC CHARACTERISTICS

 $T_j = 25 \ ^{\circ}C$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
C _{is}	input capacitance	$V_{DS} = 0; V_{GS} = -10 V; f = 1 MHz$	15	30	pF
		V_{DS} = 0; V_{GS} = 0; f = 1 MHz; T _{amb} = 25 °C	50	85	pF
C _{rs}	reverse transfer capacitance	$V_{DS} = 0; V_{GS} = -10 V; f = 1 MHz$	8	15	pF
Switching times; see Fig.2					
t _d	delay time	note 1	2	-	ns
t _{on}	turn-on time		4	-	ns
t _s	storage time		4	-	ns
t _{off}	turn-off time		6	-	ns

Note

$$\begin{split} V_{DD} &= 1.5 \text{ V}; \text{ } \text{V}_{GS} = 0 \text{ to } \text{ } \text{V}_{GSoff} \text{ (all types)} \\ V_{GSoff} &= -12 \text{ } \text{V}; \text{ } \text{R}_{L} = 100 \ \Omega \text{ } \text{(J108)} \\ \text{ } \text{V}_{GSoff} &= -7 \text{ } \text{V}; \text{ } \text{R}_{L} = 100 \ \Omega \text{ } \text{(J109)} \end{split}$$

 $V_{GSoff} = -5 V; R_{L} = 100 \Omega (J110).$



^{1.} Test conditions for switching times are as follows:

J108; J109; J110



J108; J109; J110

PACKAGE OUTLINE



J108; J109; J110

DEFINITIONS

Data Sheet Status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values	Limiting values			
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				
Application information				

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for JFET category:

Click to view products by NXP manufacturer:

Other Similar products are found below :

MCH3914-8-TL-H F5606 2SK536-TB-E SMMBF4393LT1G 2SK2394-6-TB-E CPH3910-TL-E CPH5901F-TL-E CPH5901G-TL-E CPH5902H-TL-E 424147G TF202THC-4-TL-H MCH3914-7-TL-H MCH5908H-TL-E DSK5J01R0L CPH5902G-TL-E CPH5905G-TL-E CPH5905H-TL-E 2SK304E-SPA 2SK545-11D-TB-E 2SK771-5-TB-E 2SK2539-7-TB-E 2SK932-22-TB-E 2SK2394-7-TB-E NSVJ2394SA3T1G MMBFJ175LT3G SMPJ270TR 2SK208-GR(TE85L) MMBF4416 MMBF5103 MMBF5484 MMBFJ175 MMBFJ176 MMBFJ270 MMBF4393 NPT1004D 2SK1069-5-TL-E 2SA1781-6-TB-E NSVJ3910SB3T1G 2N5116 2N5116 CMPF4392 TR 2N4092 2N4093 CMPP6028 TR 2N4117 2N3958 SNJ450113 IFN3993 IFN5911 IFN406